# INTEGRATED CIRCUITS

# DATA SHEET

# GTL16612 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

Product data Supersedes data of 2000 Jun 19





# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

GTL16612

### **FEATURES**

- 18-bit bidirectional bus interface
- Translates between GTL/GTL+ logic levels (B ports) and LVTTL/TTL logic levels (A ports)
- 5 V I/O tolerant on the LVTTL/TTL side (A ports)
- No bus current loading when LVTTL/TTL output is tied to 5 V bus
- 3-State buffers
- Output capability: +64 mA/-32 mA on the LVTTL/TTL side (A ports); +40 mA on the GTL/GTL+ side (B ports)
- TTL input levels on control pins
- Power-up reset
- Power-up 3-State
- Positive edge triggered clock inputs
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114, 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

### **DESCRIPTION**

The GTL16612 is a high-performance BiCMOS product designed for  $V_{CC}$  operation at 3.3 V with I/O compatibility up to 5 V.

This device is an 18-bit universal transceiver featuring non-inverting 3-State bus compatible outputs in both send and receive directions. Data flow in each direction is controlled by output enable (OEAB and OEBA), latch enable (LEAB and LEBA), and clock (CPAB and CPBA) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is High. When LEAB is Low, the A data is latched if CPAB is held at a High or Low logic level. If LEAB is Low, the A-bus data is stored in the latch/flip-flop on the Low-to-High transition of CPAB. When OEAB is Low, the outputs are active. When OEAB is High, the outputs are in the high-impedance state. The clocks can be controlled with the clock-enable inputs (CEBA/CEAB).

Data flow for B-to-A is similar to that of A-to-B but uses OEBA, LEBA and CPBA.

### QUICK REFERENCE DATA

OVMDOL	DARAMETER	CONDITIONS	TYPICAL	
SYMBOL	PARAMETER	T <sub>amb</sub> = 25 °C	3.3 V	UNIT
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation delay An to Bn or Bn to An	C <sub>L</sub> = 50 pF	1.9	ns
C <sub>IN</sub>	Input capacitance (Control pins)	V <sub>I</sub> = 0 V or V <sub>CC</sub>	4	pF
C <sub>I/O</sub>	I/O pin capacitance	Outputs disabled; V <sub>I/O</sub> = 0 V or V <sub>CC</sub>	8	pF
Iccz	Total supply current	Outputs disabled	12	mA

# ORDERING INFORMATION

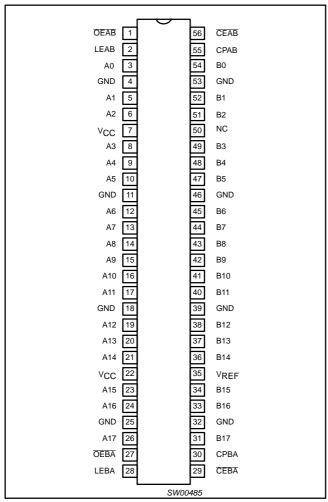
PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER	
56-Pin Plastic SSOP	-40 to +85 °C	GTL16612DL	SOT371-1	
56-Pin Plastic TSSOP	-40 to +85 °C	GTL16612DGG	SOT364-1	

Standard packing quantities and other packaging data is available at www.philipslogic.com/packaging.

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# **PIN CONFIGURATION**



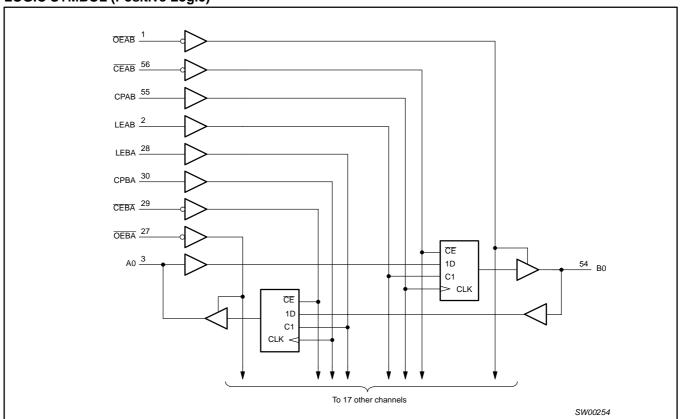
# **PIN DESCRIPTION**

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1, 27	OEAB/OEBA	A-to-B/ B-to-A Output enable input (active Low)
29, 56	CEBA/CEAB	B-to-A/A-to-B clock enable
2, 28	LEAB/LEBA	A-to-B/B-to-A Latch enable input
55,30	CPAB/CPBA	A-to-B/B-to-A Clock input (active rising edge)
3, 5, 6, 8, 9, 10, 12, 13, 14, 15, 16, 17, 19, 20, 21, 23, 24, 26	A0-A17	Data inputs/outputs (A side)
54, 52, 51, 49, 48, 47, 45, 44, 43, 42, 41, 40, 38, 37, 36, 34, 33, 31	B0-B17	Data inputs/outputs (B side)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0 V)
7, 22	V <sub>CC</sub>	Positive supply voltage
35	$V_{REF}$	GTL reference voltage
50	NC	No connection

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# **LOGIC SYMBOL (Positive Logic)**



# **FUNCTION TABLE**

	INPUTS						
CEAB <sup>1</sup>	OEAB <sup>1</sup>	LEAB <sup>1</sup>	CPAB <sup>1</sup>	Α	В		
Х	Н	Х	Х	Х	Z		
Х	L	Н	Х	L	L		
Х	L	Н	Х	Н	Н		
Н	L	L	Х	Х	B <sub>O</sub> <sup>2</sup>		
Н	L	L	Х	Х	B <sub>O</sub> <sup>2</sup>		
L	L	L	1	L	L		
L	L	L	1	Н	Н		
L	L	Ĺ	Н	Х	B <sub>O</sub> <sup>2</sup>		
L	L	L	L	Х	$B_0^3$		

- X = Don't care
- H = High voltage level
  L = Low voltage level
- ↑ = Low to High
- Z = High impedance "off" state
- 1. A-to-B data flow is shown: B-to-A flow is similar but uses OEBA, LEBA, CPBA, and CEBA.
- 2. Output level before the indicated steady-state input conditions were established.
- 3. Output level before the indicated steady-state input conditions were established, provided that CPAB was Low before LEAB went Low.

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# **ABSOLUTE MAXIMUM RATINGS 1, 2**

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V <sub>CC</sub>	DC supply voltage		-0.5 to +4.6	V
I <sub>IK</sub>	DC input diode current	V <sub>I</sub> < 0	-50	mA
V	DC innuturalisma3	A port	-0.5 to +7.0	V
VI	DC input voltage <sup>3</sup>	B port	-0.5 to +4.6	V
I <sub>OK</sub>	DC output diode current	V <sub>O</sub> < 0; A port	-50	mA
M	DC sydneyd collages 3	Output in Off or High state; A port	-0.5 to +7.0	V
Vo	DC output voltage <sup>3</sup>	Output in Off or High state; B port	-0.5 to +4.6	V
-	Command into any output in the LOW state	A port	128	mA
l <sub>OL</sub>	Current into any output in the LOW state	B port	80	mA
I <sub>OH</sub>	Current into any output in the HIGH state	A port	-64	mA
T <sub>stg</sub>	Storage temperature range		-65 to +150	°C

# NOTES:

- 1. Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

  The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction
- temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.
- 3. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.

### RECOMMENDED OPERATING CONDITIONS

OVMDOL	DADAMETER	TEST COMPITIONS	3.3 V RAN	IGE LIMITS	UNIT	
SYMBOL	PARAMETER	TEST CONDITIONS	MIN	MAX	ן יייי	
V <sub>CC</sub>	DC supply voltage		3.0	3.6	V	
	Townsing stiene welfer an	GTL	1.14	1.26	V	
$V_{TT}$	Termination voltage	GTL <sup>+</sup>	1.35	1.65	<b>1</b>	
	CTI reference valle se	GTL	0.74	0.87	V	
$V_{REF}$	GTL reference voltage	GTL <sup>+</sup>	0.9	1.10	<b>1</b>	
W	Input voltage	B port	0	V <sub>TT</sub>	V	
VI		Except B port		0 5.5		<b>1</b>
\ /	LUCI Llevel innut velte ne	B port	V <sub>REF</sub> +50 mV		V	
$V_{IH}$	HIGH-level input voltage	Except B port	2.0		<b>1</b>	
V	LOW lovel is not value	B port		V <sub>REF</sub> -50 mV	V	
$V_{IL}$	LOW-level input voltage	OW-level input voltage Except A port		0.8	<b>1</b>	
I <sub>OH</sub>	HIGH-level output current	A port		-32	mA	
	LOW/Journal autout automate	B port		40	A	
l <sub>OL</sub>	LOW-level output current	A port		64	- mA	
T <sub>amb</sub>	Operating free-air temperature range		-40	+85	°C	

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# DC ELECTRICAL CHARACTERISTICS (3.3 V $\pm$ 0.3 V RANGE)

						LIMITS		
SYMBOL	PARAMETER TEST CONDITIONS				Temp =	Temp = -40 to +85 °C		
					MIN	TYP <sup>1</sup>	MAX	
V <sub>IK</sub>	Input clamp vo	ltage	$V_{CC} = 3.0 \text{ V; } I_{IK} = -18 \text{ mA}$			-0.85	-1.2	V
.,			$V_{CC} = 3.0 \text{ to } 3.6 \text{ V}; I_{OH} = -100 \mu\text{A}$		V <sub>CC</sub> -0.2	$V_{CC}$		.,
V <sub>OH</sub>	High-level outp	out voltage	V <sub>CC</sub> = 3.0 V; I <sub>OH</sub> = -32 mA	- A port	2.0	2.3		V
			$V_{CC} = 3.0 \text{ V}; I_{OL} = 100 \mu\text{A}$			0.07	0.2	
			V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 16 mA	<b>1</b>		0.25	0.4	V
$V_{OL}$	Low-level outp	out voltage	V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 32 mA	A port		0.3	0.5	V
			V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 64 mA	1		0.4	0.55	
			V <sub>CC</sub> = 3.0 V; I <sub>OL</sub> = 40 mA	B port		0.4	4 0.5 V	
			$V_{CC} = 3.6 \text{ V}; V_I = V_{CC} \text{ or GND}$	O a stool of a		0.1	±1	_
			V <sub>CC</sub> = 0 or 3.6 V; V <sub>I</sub> = 5.5 V	CC = 0 or 3.6 V; V <sub>I</sub> = 5.5 V		0.1	10	μΑ
			V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 5.5 V			0.1	20	
I <sub>I</sub>	Input leakage current		V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = V <sub>CC</sub>	I/O Data pins <sup>4</sup> A port		0.5	10	μΑ
			V <sub>CC</sub> = 3.6 V; V <sub>I</sub> = 0	A port		0.1	-5	
			$V_{CC} = 3.6 \text{ V}; V_I = V_{TT} \text{ or GND}$	B port			±5	μΑ
I <sub>OFF</sub>	Output off curre	ent	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 0 \text{ to } 4.5 \text{ V}$			0.1	±100	μΑ
	D Hald		V <sub>CC</sub> = 3 V; V <sub>I</sub> = 0.8 V		75	130		
I <sub>HOLD</sub>	Bus Hold curre	ent, A outputs	V <sub>CC</sub> = 3 V; V <sub>I</sub> = 2.0 V		-75	-140		μΑ
I <sub>EX</sub>	Current into an High state whe	output in the en V <sub>O</sub> > V <sub>CC</sub>	V <sub>O</sub> = 5.5 V; V <sub>CC</sub> = 3.0 V	A port		10	125	μΑ
I <sub>PU/PD</sub>	Power up/dowi		$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC}; V_O = 0.5 \text{ Derive}$	$V_{I} = GND \text{ or } V_{CC}$		1.0	±100	μА
Іссн			Outputs high			5.0	9.0	
I <sub>CCL</sub>	A-Port		Outputs low	1		10.5	18.5	
I <sub>CCZ</sub> 5		V <sub>CC</sub> = 3.6 V	Disabled	$V_I = GND \text{ or } V_{CC_1} I_O = 0$		6.0	11.5	mA
I <sub>CCH</sub>	D. Dawl	]	Outputs high			9.7	17.5	
I <sub>CCL</sub>	B-Port		Outputs low			7.0	12.0	
$\Delta I_{CC}$	Additional supplinput pin <sup>2</sup>	ply current per	V <sub>CC</sub> = 3 V to 3.6 V; One input at V Other inputs at V <sub>CC</sub> or GND	/ <sub>CC</sub> -0.6 V,		0.04	0.2	mA

- All typical values are at V<sub>CC</sub> = 3.3 V and T<sub>amb</sub> = 25 °C.
   This is the increase in supply current for each LVTTL input at the specified voltage level other than V<sub>CC</sub> or GND
   This parameter is valid for any V<sub>CC</sub> between 0 V and 1.2 V with a transition time of up to 10 msec. From V<sub>CC</sub> = 1.2 V to V<sub>CC</sub> = 3.3 V ± 0.3 V a transition time of 100  $\mu$ sec is permitted. This parameter is valid for  $T_{amb} = 25$ °C only.
- 4. Unused pins at  $V_{CC}$  or GND.

  5.  $I_{CCZ}$  is measured with outputs pulled up to  $V_{CC}$  or pulled down to ground.

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# **AC CHARACTERISTICS (A PORT)**

GND = 0 V;  $t_r$  =  $t_f$  = 2.5 ns;  $C_L$  = 50 pF;  $R_L$  = 500  $\Omega$ ;  $T_{amb}$  = -40 to +85 °C.

				GTL			GTL+		
	GTL16612 An Port			$V_{CC}$ = 3.3 V $\pm$ 0.3 V		$V_{CC}$ = 3.3 V ±0.3 V			LINUT
			,	V <sub>REF</sub> = 0.8 \	/	,	/ <sub>REF</sub> = 1.0 \	/	UNIT
SYMBOL	PARAMETER	WAVEFORM	MIN	TYP <sup>1</sup>	MAX	MIN	TYP <sup>1</sup>	MAX	1
t <sub>PLH</sub>	Bn to An	2	1.6	3.0	5.0	1.6	3.0	5.0	ns
t <sub>PHL</sub>	Bn to An	2	3.0	4.9	6.3	3.0	4.9	6.3	ns
t <sub>PLH</sub>	LEBA to An	3	1.6	2.7	4.2	1.6	2.7	4.2	ns
t <sub>PHL</sub>	LEBA to An	3	1.6	2.8	4.3	1.6	2.8	4.3	ns
t <sub>PLH</sub>	CPBA to An	1	1.9	3.4	4.7	1.9	3.4	4.7	ns
t <sub>PHL</sub>	CPBA to An	1	1.8	3.8	5.2	1.8	3.8	5.2	ns
t <sub>PZH</sub>	OEBA to An	5	1.5	2.6	4.2	1.5	2.6	4.2	ns
t <sub>PHZ</sub>	OEBA to An	5	1.4	2.9	4.8	1.4	2.9	4.8	ns
t <sub>PZL</sub>	OEBA to An	6	1.3	2.4	3.8	1.3	2.4	3.8	ns
t <sub>PLZ</sub>	OEBA to An	6	1.2	2.2	3.5	1.2	2.2	3.5	ns

NOTE:

# **AC CHARACTERISTICS (B PORT)**

GND = 0 V;  $t_r$  =  $t_f$  = 2.5 ns;  $C_L$  = 30 pF;  $R_L$  = 25  $\Omega$ ;  $T_{amb}$  = -40 to +85 °C.

				GTL			GTL+		
	GTL16612 Bn Port			c = 3.3 V ±0.	.3 V	Vcc	; = 3.3 V ±0.	3 V	1
			,	V <sub>REF</sub> = 0.8 \	/	,	/ <sub>REF</sub> = 1.0 \	1	UNIT
SYMBOL	PARAMETER	WAVEFORM	MIN	TYP <sup>1</sup>	MAX	MIN	TYP <sup>1</sup>	MAX	1
t <sub>PLH</sub>	An to Bn	2	1.4	2.4	3.7	1.3	2.4	3.7	ns
t <sub>PHL</sub>	An to Bn	2	1.3	2.5	4.0	1.4	2.6	4.2	ns
t <sub>PLH</sub>	LEAB to Bn	3	1.7	3.0	4.4	1.8	3.0	4.6	ns
t <sub>PHL</sub>	LEAB to Bn	3	2.1	3.5	5.4	2.3	3.6	5.5	ns
t <sub>PLH</sub>	CPAB to Bn	1	1.8	3.1	4.5	1.9	3.1	4.8	ns
t <sub>PHL</sub>	CPAB to Bn	1	2.3	3.6	5.4	2.4	3.8	5.8	ns
t <sub>PLH</sub>	OEAB to Bn	7	1.1	2.1	3.3	1.4	2.0	3.5	ns
t <sub>PHL</sub>	OEAB to Bn	7	1.6	2.8	4.4	1.0	2.9	4.5	ns

NOTE:

<sup>1.</sup> Typical values are at  $V_{CC}$  = 3.3 V,  $T_{amb}$  = +25 °C.

<sup>1.</sup> Typical values are at  $V_{CC}$  = 3.3 V,  $T_{amb}$  = +25 °C.

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# AC SETUP REQUIREMENTS (3.3 V $\pm 0.3$ V RANGE)

A Port: GND = 0 V; Input  $t_r = t_f = 2.5 \text{ ns}$ ;  $C_L = 50 \text{ pF}$ ;  $R_L = 500 \Omega$ ;  $T_{amb} = -40 \text{ to } +85 \,^{\circ}\text{C}$ ;  $V_{REF} = 0.8 \text{ V or } 1.0 \text{ V}$ . B Port: GND = 0 V; Input  $t_r = t_f = 2.5 \text{ ns}$ ;  $C_L = 30 \text{ pF}$ ;  $R_L = 25 \Omega$ ;  $V_{REF} = 0.8 \text{ V or } 1.0 \text{ V}$ .

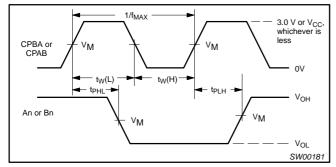
			LIN	LIMITS		
SYMBOL	PARAMETER	WAVEFORM	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		UNIT	
			MIN	MAX	1	
t <sub>s</sub> (H)	Setup time, High or Low	4	1.5		ns	
t <sub>s</sub> (L)	Bn to CPBA	4	1.5		ns	
t <sub>s</sub> (H)	Setup time, High or Low	4	2.0		ns	
t <sub>s</sub> (L)	An to CPAB	4	3.0		ns	
t <sub>h</sub> (H)	Hold time, High or Low	4	1.0		ns	
t <sub>h</sub> (L)	Bn to CPBA, or An to CPAB	4	1.0		ns	
t <sub>s</sub> (H)	Setup time, High or Low	4	1.0		ns	
t <sub>s</sub> (L)	Bn to LEBA, or An to LEAB	4	1.0		ns	
t <sub>h</sub> (H)	Hold time, High or Low	4	1.5		ns	
t <sub>h</sub> (L)	Bn to LEBA, or An to LEAB	4	1.5		ns	
t <sub>s</sub> (H)	Setup time, High or Low	4	1.0		ns	
t <sub>s</sub> (L)	CEAB to CPAB, or CEBA to CPBA	4	1.0		ns	
t <sub>h</sub> (H)	Hold time, High or Low	4	1.5		ns	
t <sub>h</sub> (L)	CEAB to CPAB, or CEBA to CPBA	4	1.0		ns	
t <sub>w</sub> (H)	Pulse width, High or Low	4	2.0		ns	
t <sub>w</sub> (L)	CPBA or CPAB	4	2.0		ns	
t <sub>w</sub> (H)	Pulse width, High LEBA or LEAB	3	1.5		ns	

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

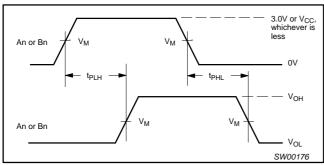
GTL16612

#### **AC WAVEFORMS**

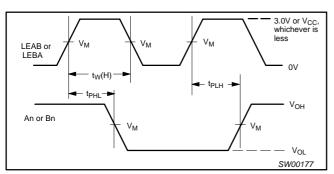
 $V_M$  = 1.5 V at  $V_{CC} \ge 3.0$  V.  $V_M$  = 1.5 V for A ports and control pins;  $V_M$  = 0.8 V for B ports in GTL mode;  $V_M$  = 1.0 V for B ports in GTL+ mode.  $V_X = V_{OL} + 0.3$  V at  $V_{CC} \ge 3.0$  V.  $V_Y = V_{OH} - 0.3$  V at  $V_{CC} \ge 3.0$  V.



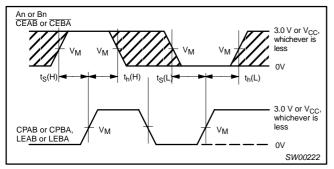
Waveform 1. Propagation delay, clock input to output, clock pulse width, and maximum clock frequency



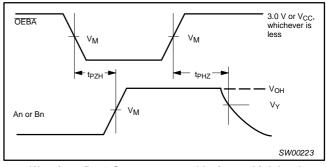
Waveform 2. Propagation delay, transparent mode



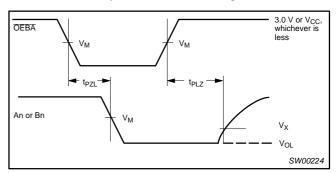
Waveform 3. Propagation delay, enable to output, and enable pulse width



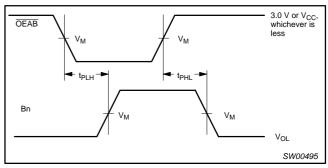
Waveform 4. Data setup and hold times



Waveform 5. 3-State output enable time to high level and output disable time from high level



Waveform 6. 3-State output enable time to low level and output disable time from low level

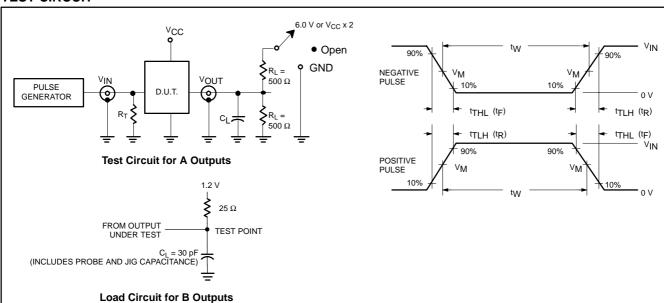


Waveform 7. Output enable time on open collector output with pullup

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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### **TEST CIRCUIT**



# **SWITCH POSITION**

TEST	SWITCH
t <sub>PLZ</sub> /t <sub>PZL</sub>	6 V
t <sub>PLH</sub> /t <sub>PHL</sub>	Open
t <sub>PHZ</sub> /t <sub>PZH</sub>	GND

# **DEFINITIONS**

R<sub>L</sub> = Load resistor; see AC CHARACTERISTICS for value.

 $R_T$  = Termination resistance should be equal to  $Z_{OUT}$  of pulse generators.

	INPUT PULSE REQUIREMENTS							
FAMILY	Amplitude	Rep. Rate	t <sub>W</sub>	t <sub>R</sub>	t <sub>F</sub>			
74GTL16	3.0 V or V <sub>CC</sub> whichever is less	≤10 MHz	500 ns	≤2.5 ns	≤2.5 ns			

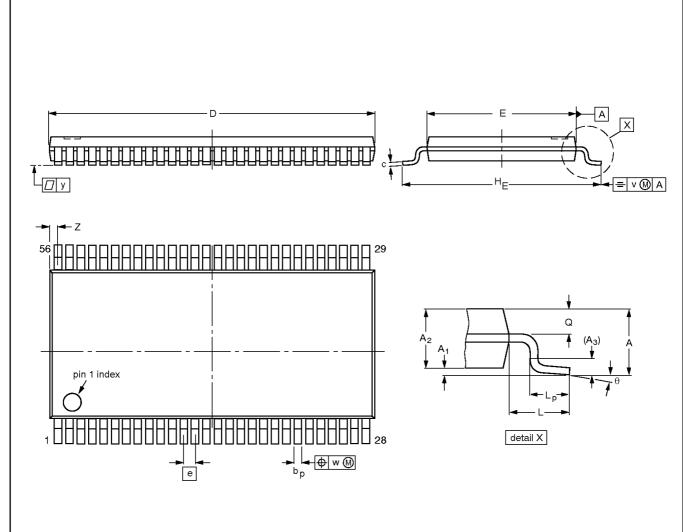
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# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

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# TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



# 0 2.5 5 mm scale

### DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	bp	O	D <sup>(1)</sup>	E <sup>(2)</sup>	e	HE	٦	Lp	Q	>	V	у	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

#### Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE	
SOT364-1		MO-153EE				<del>-93-02-03</del> 95-02-10	

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

GTL16612

# **REVISION HISTORY**

Rev	Date	Description
_4	20021213	Product data (9397 750 10862); ECN 853-2166 29245 of 03 December 2002
		Modifications:
		New package release.
_3	20000619	Product data (9397 750 07217); ECN 853-2166 23903 of 19 June 2000.

# 18-bit GTL/GTL+ to LVTTL/TTL bidirectional universal translator (3-State)

GTL16612

### **Data sheet status**

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2] [3]</sup>	Definitions
ı	Objective data	Development	This data sheet contains data from the objective specification for product development.  Philips Semiconductors reserves the right to change the specification in any manner without notice.
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- [2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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